

A Message | From the SVC Foundation Chair

The SVC Foundation (SVCF) is entering its seventh year, with plans to award four scholarships in 2009, and with three scholarship awardees from 2008 planning to attend the SVC TechCon. We feel that the financial assistance given to qualified students studying vacuum coatings academically coupled with attendance at the SVC TechCon to learn about the current state of the technology and to meet practitioners distinguishes us from your average scholarship fund. We offer a cost effective way for people to give back to the field. So, we suggest that you consider us in your charitable giving plans. Your contribution can go all the way from a donation with your SVC membership renewal, to sponsoring and/or participating in the 5K Fun Run, making a donation to the Foundation or one of its funds, or making a major grant that would endow a scholarship in your name or in the memory of another. Remember your donation can be tax free in the USA.

SVC Support Through Matching Funds

The SVC has established a Matching Challenge Grant, which will match every donation in excess of \$1,000 up to \$10,000 in one year. This is one of the many ways in which the SVC supports the Foundation. We encourage those donors with adequate resources to take advantage of multiplying your donation through this Matching Challenge Grant.

The Bernard Henry Fund

In February 2007, the industry lost a respected scientist and friend in Dr. Bernard Henry. His sudden passing was a shock to all that knew him and his contributions to AIMCAL and SVC are greatly missed. The Bernard Henry Fund was created cooperatively between the SVC and AIMCAL in Bernard's memory. It has surpassed \$47,000 in total and this year should reach the \$50,000 minimum necessary for becoming endowed. The fund made impressive growth through the efforts and donations of AIMCAL, SVC, and 2008

donations by many corporate and private donors, including: Amcor Flexibles, Toppan Printing Co., Ltd., Aker Cool Sorption A/S, 3M ActiveFlex Team, The Seeser Family Fund, Fennagain, and the J. Reading Whiskey Tasting.

Donations for this fund should be made payable to the SVC Foundation, 8100 M-4 Wyoming Blvd. NE #243, Albuquerque, NM 87113 USA. Please specify the Bernard Henry AIMCAL-SVC Scholarship Fund on your checks. The larger this fund becomes, the more scholarships can be given.

New and Retiring SVCF Board Members



Steve Sedlak

The SVCF Board wishes to recognize the contributions of John Marcantonio, who is retiring from the Board after serving three years as Secretary. John is being replaced as Secretary by Steve Sedlak for a six-year term. Steve has been in the vacuum metallizing and coating industry since 1981, having worked for Vacumet Corporation, Dunmore Corporation, and Precision Coatings in positions including sales, marketing, purchasing, production, and general management. Currently Steve is Sales Manager for ESK Ceramics - A Ceradyne Company. In 1998 he became the AIMCAL Awards Committee Chairman, recognizing significant product and technology advancements in the industry. He also serves on the AIMCAL Board of Directors. Steve's involvement with SVC and AIMCAL will strengthen the Foundation's reach in the industry.

Treasurer's Report

The SVC Foundation continues to move forward even in the extremely challenging economic atmosphere of 2008. Although

we lost some money on our invested Fund Balance (approx. 10%), this was not as bad as many experienced. Furthermore, we made significant progress towards our goal of \$50K in the Bernard Henry Fund, reaching \$47K at years end, thanks to very generous donations by AIMCAL, SVC and several corporations and individuals. AIMCAL continues to lead the development of this fund. We are looking forward to 2009 and a better economic climate. We hope to increase our donations in the coming year and reach a fund balance of \$250K by years end.

Scholarship Awardees at Techcon



Michael Orthner

The SVC Foundation will host the 2008 scholarship awardees at TechCon in Santa Clara. Michael Orthner, PhD candidate in Electrical and Computer Engineering at the University of Utah, will present a Poster

entitled, "The Design and Development of an LPCVD Reactor for the Growth of 3C-SiC on Si." Michael had the following comment about the opportunity to attend the SVC Technical Conference: "This networking opportunity should not be undervalued since it is one of the rare times as a student you personally interact with world experts in your field."

The other 2008 scholarship winners attending TechCon are Jon Hansen, undergraduate Engineering student from Grand Valley State University and Bahkthiyar Ali, graduate student from the University of Delaware.

SVCF Booth

The SVC Foundation will be in booth 808 and will be manned by Foundation Board Members. We invite you to stop by during the TechCon to learn more about the important work being done by the Foundation.

SVC Foundation Board of Directors:

James W. Seeser, Chair, OCLI and JDS Uniphase (retired), (314/918-0160; jseeser@aol.com)

John Felts, Vice Chair and Treasurer, Nano Scale Surface Systems, Inc. (510/814-0340; felts.dnai@rcn.com)

Steve Sedlak, Secretary, ESK Ceramics - A Ceradyne Company (800/833-7608; ssedlak@ceradyne.com)

Paolo Raugai, Scholarship Committee Chair, Galileo Vacuum Systems, Inc. (678/513-0303; praugai@worldnet.att.net)

John B. Fenn, Jr., Fund Raising Chair, Fennagain (818/888-8649; johnfenn@earthlink.net)

Wolfgang Decker, 5K Run Organizer, SVC Board Representative. VAST FILMS, Ltd. (724/827-8827; w.decker@vastfilm.com)

News | About the SVC Foundation

Fourth Annual SVCF 5K Run/Walk, Tuesday, May 12, 6:00 a.m.

The third annual 5K Fun Run and Walk benefitting the Society of Vacuum Coaters Foundation was a successful fundraising event at the 51st Technical Conference in Chicago in April, 2008, raising nearly \$9,000 for the Foundation scholarship program. About 60 participants had a beautiful early morning workout as they walked or jogged on the River Walk that runs parallel to the Chicago River and along Lake Michigan's shoreline, where they were greeted by an amazing sunrise over the lake.

The Foundation is again organizing a 5K Fun Run and Walk for the 2009 Technical Conference in Santa Clara, CA. The event will take place early Tuesday morning in the park areas behind the convention center, where there are off-traffic walking and bicycle paths. Once again, organizers are looking for sponsors for this growing event. The sponsors will have their logo prominently displayed


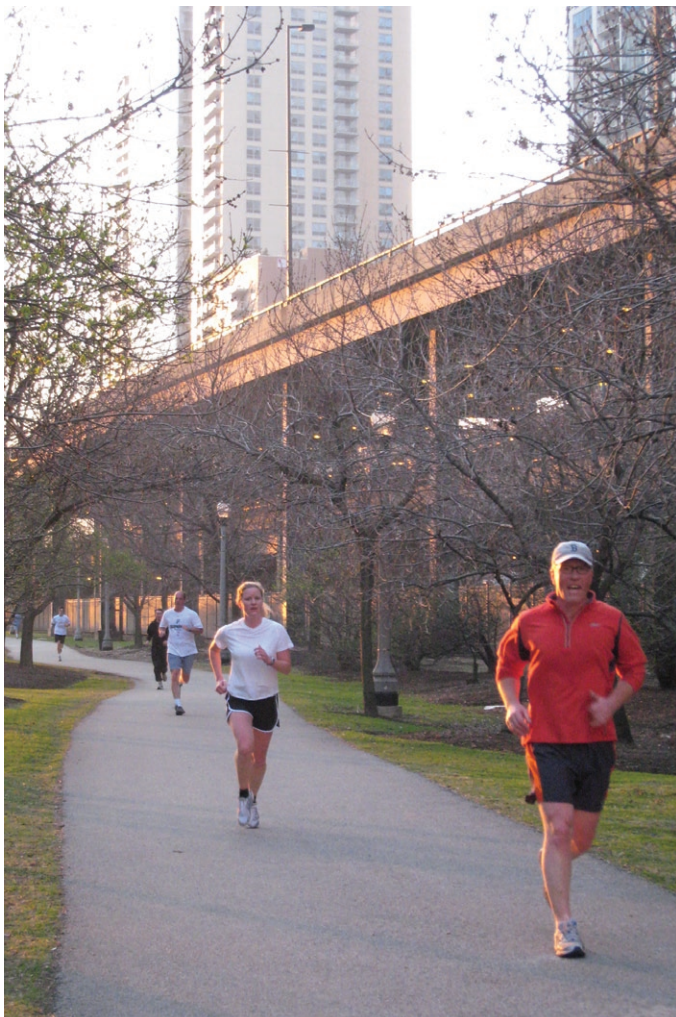
on the T-shirt that is given to all participants, and they will receive an honorable mention with their logos in the program. The sponsor fees will go directly to the Foundation and help to further the efforts of the SVCF. If you would like to sponsor the 2009 event, contact Wolfgang Decker at w.decker@vastfilm.com.

Make plans to join us as a runner or walker in Santa Clara and encourage a friend or colleague to participate. You can sign up for the event when you register for the TechCon at www.svc.org. To learn more about the SVC Foundation or to make a contribution, visit www.svcfoundation.org.

Current 2009 sponsors include:

Applied Materials
John Fenn (Fennagain)
Gencoa Ltd.
Nano Scale Surface Systems, Inc.
VAST Films, Ltd.

The SVC Foundation would once again like to thank the sponsors for the 2008 event who helped the Foundation raise almost \$9,000. These sponsors included: Academy Corporation, Advanced Energy Industries, Inc., AIMCAL, Angstrom Sciences, Inc., Applied Materials, ESK Ceramics USA - A Ceradyne Company, Fennagain, Galileo Vacuum Systems, Inc., Gencoa Ltd., GENERAL Vacuum Equipment Ltd., Gfe Materials Technology, Inc., Jim Seeser, John Marcantonio, Nano Scale Surface Systems, Inc., PBI-Dansensor America, Inc., SAGE industrial sales, inc., Sierra Applied Sciences, Sigma Technologies International, Inc., Sintec Keramik USA, Inc., Soleras Ltd., Vacuum Depositing, Inc., and VAST Films, Ltd. If you would like to sponsor the 2009 event, contact Wolfgang Decker at w.decker@vastfilm.com.



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on
SPUTTERING & PLASMA PROCESSES

July 8-10, 2009
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Symposium /Poster Session /Industrial Exhibition

Topical Theme:
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in Sputtering and Plasma Processes

Abstract Deadline: January 19, 2009

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